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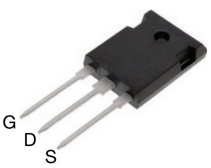
Vishay/Siliconix
SIHW30N60E-GE3

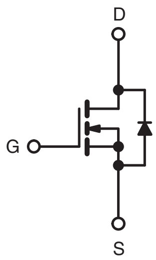
For any questions, you can email us directly:
sales@integrated-circuit.com

E Series Power MOSFET

PRODUCT SUMMARY		
V_{DS} (V) at T_J max.	650	
$R_{DS(on)}$ max. at 25 °C (Ω)	V_{GS} = 10 V	0.125
Q_g max. (nC)	130	
Q_{gs} (nC)	15	
Q_{gd} (nC)	39	
Configuration	Single	

TO-247AD





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) R_{on} x Q_g
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
  - LED lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- Battery chargers
- Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and Halogen-free	SiHW30N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

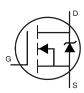
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	V
Gate-Source Voltage			V_{GS}	± 20	
Gate-Source Voltage AC (f > 1 Hz)				30	
Continuous Drain Current (T_J = 150 °C)	V_{GS} at 10 V	T_C = 25 °C	I_D	29	A
		T_C = 100 °C		18	
Pulsed Drain Current[a]			I_{DM}	65	
Linear Derating Factor				2	W/°C
Single Pulse Avalanche Energy[b]			E_{AS}	690	mJ
Maximum Power Dissipation			P_D	250	W
Operating Junction and Storage Temperature Range			T_J, T_{stg}	-55 to +150	°C
Drain-Source Voltage Slope	V_{DS} = 0 V to 80 % V_{DS}		dV/dt	70	V/ns
Reverse Diode dV/dt[d]				18	
Soldering Recommendations (Peak Temperature)[c]	for 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.
b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω, I_{AS} = 7 A.
c. 1.6 mm from case.
d. $I_{SD} \leq I_D$, dI/dt = 100 A/μs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS				
PARAMETER	**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Maximum Junction-to-Ambient	R_{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 μA	600	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, I_D = 250 μA	-	0.64	-	V/°C
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 μA	2.0	2.8	4.0	V
Gate-Source Leakage	I_{GSS}	V_{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = 600 V, V_{GS} = 0 V	-	-	1	μA
		V_{DS} = 600 V, V_{GS} = 0 V, T_J = 150 °C	-	-	100	
Drain-Source On-State Resistance	$R_{DS(on)}$	V_{GS} = 10 V, I_D = 15 A	-	0.104	0.125	Ω
Forward Transconductance[a]	g_{fs}	V_{DS} = 8 V, I_D = 3 A	-	5.4	-	S
Dynamic						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 100 V, f = 1.0 MHz	-	2600	-	pF
Output Capacitance	C_{oss}		-	138	-	
Reverse Transfer Capacitance	C_{rss}		-	3	-	
Effective Output Capacitance, Energy Related[b]	$C_{o(er)}$	V_{DS} = 0 V to 480 V, V_{GS} = 0 V	-	98	-	
Effective Output Capacitance, Time Related[c]	$C_{o(tr)}$		-	346	-	
Total Gate Charge	Q_g	V_{GS} = 10 V, I_D = 15 A, V_{DS} = 480 V	-	85	130	nC
Gate-Source Charge	Q_{gs}		-	15	-	
Gate-Drain Charge	Q_{gd}		-	39	-	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = 380 V, I_D = 15 A, V_{GS} = 10 V, R_g = 4.7 Ω	-	19	40	ns
Rise Time	t_r		-	32	65	
Turn-Off Delay Time	$t_{d(off)}$		-	63	95	
Fall Time	t_f		-	36	75	
Gate Input Resistance	R_g	f = 1 MHz, open drain	-	0.63	-	Ω
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	29	A
Pulsed Diode Forward Current	I_{SM}		-	-	65	
Diode Forward Voltage	V_{SD}	T_J = 25 °C, I_S = 15 A, V_{GS} = 0 V	-	-	1.3	V
Body Diode Reverse Recovery Time	t_{rr}	T_J = 25 °C, I_F = I_S = 15 A, dI/dt = 100 A/μs, V_R = 20 V	-	402	605	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	7	15	μC
Reverse Recovery Current	I_{RRM}		-	32	65	A

Notes
a. Repetitive rating; pulse width limited by maximum junction temperature.
b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.
c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

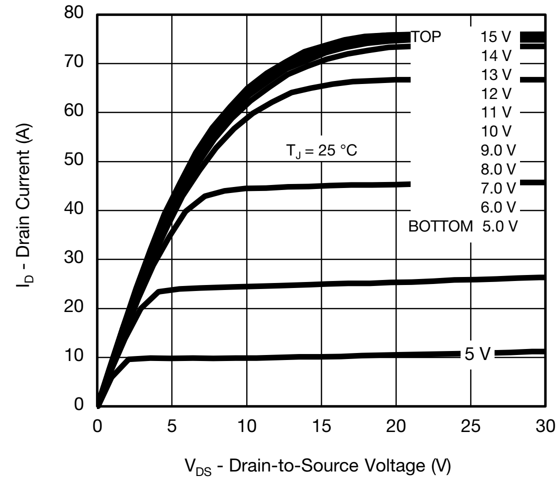


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

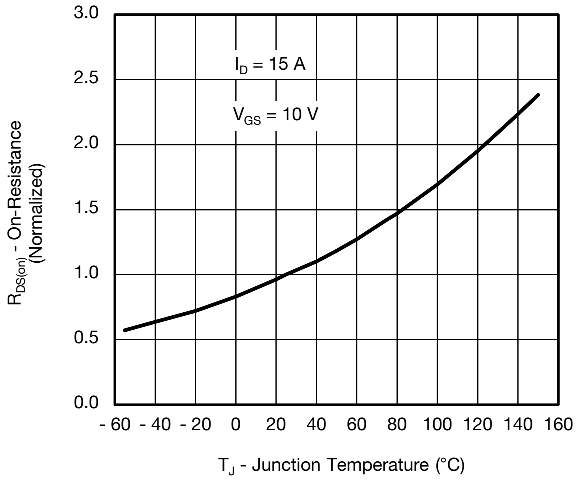


Fig. 4 - Normalized On-Resistance vs. Temperature

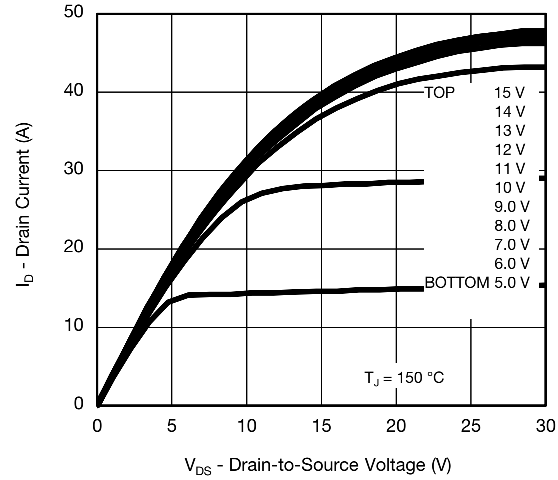


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

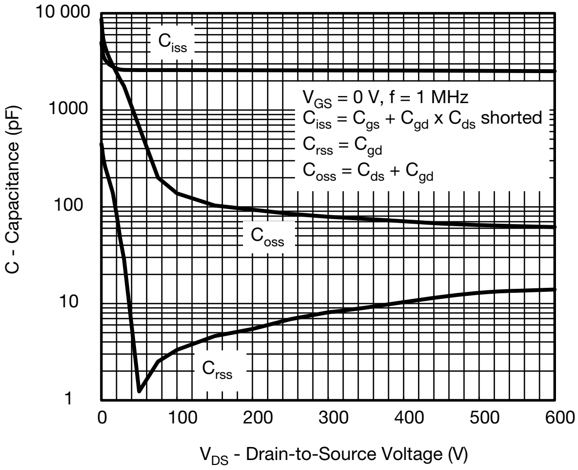


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

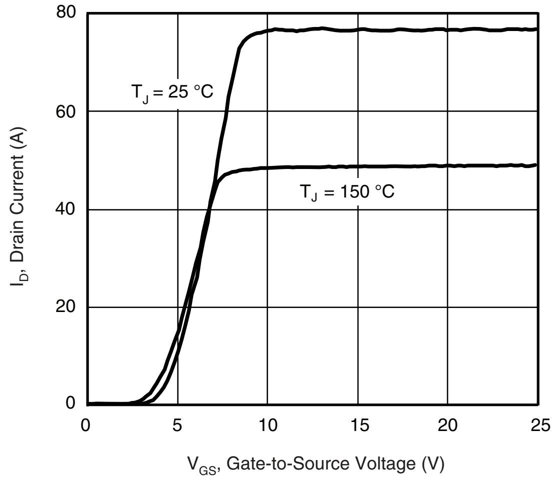


Fig. 3 - Typical Transfer Characteristics

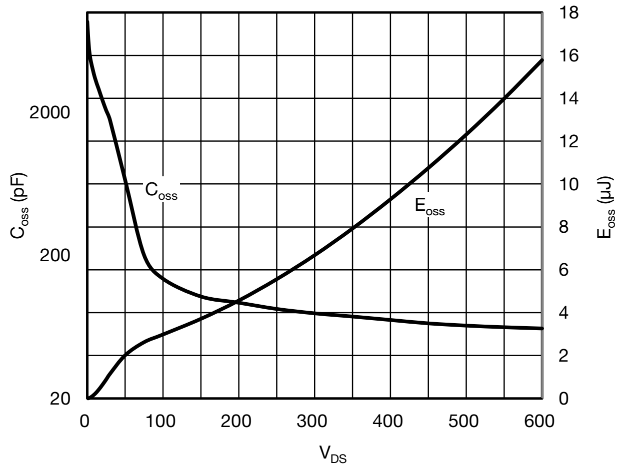


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

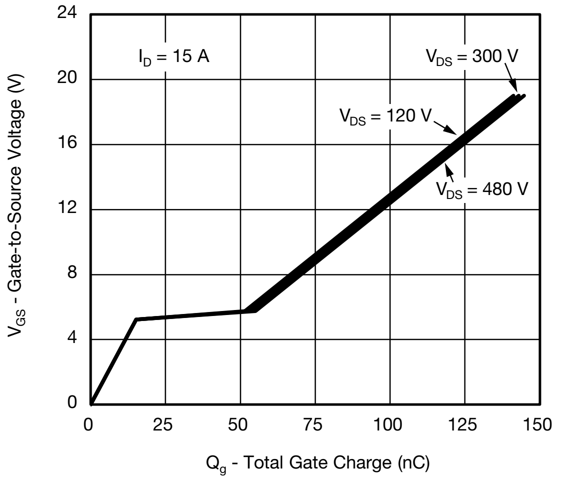


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

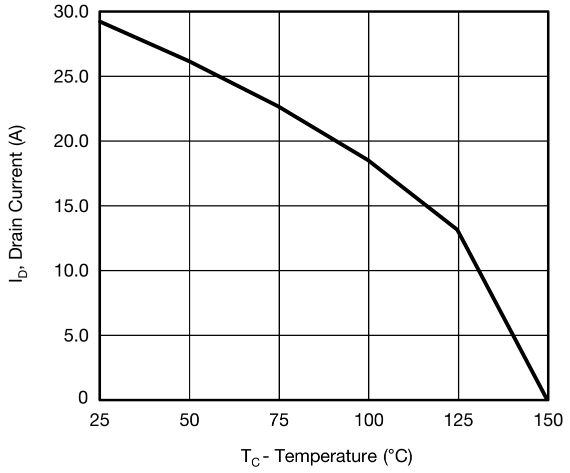


Fig. 10 - Maximum Drain Current vs. Case Temperature

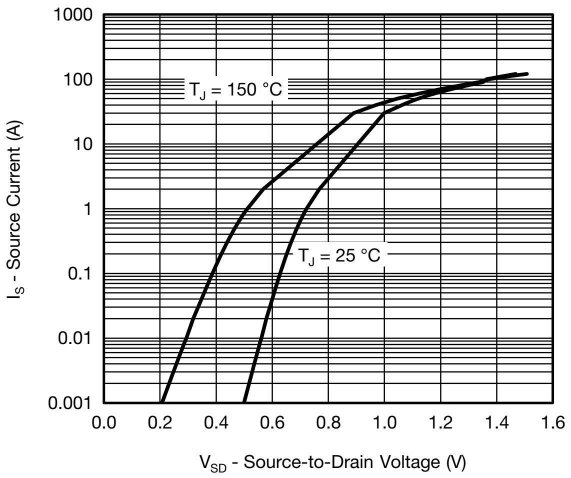


Fig. 8 - Typical Source-Drain Diode Forward Voltage

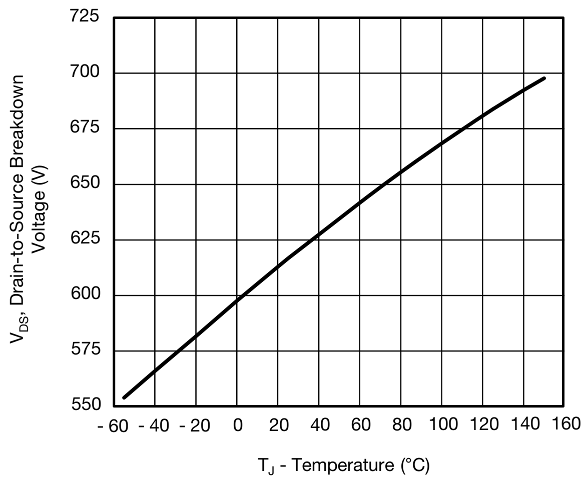
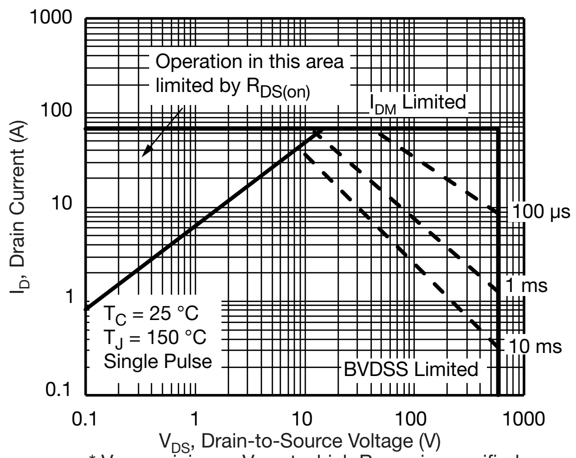


Fig. 11 - Temperature vs. Drain-to-Source Voltage



* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Fig. 9 - Maximum Safe Operating Area

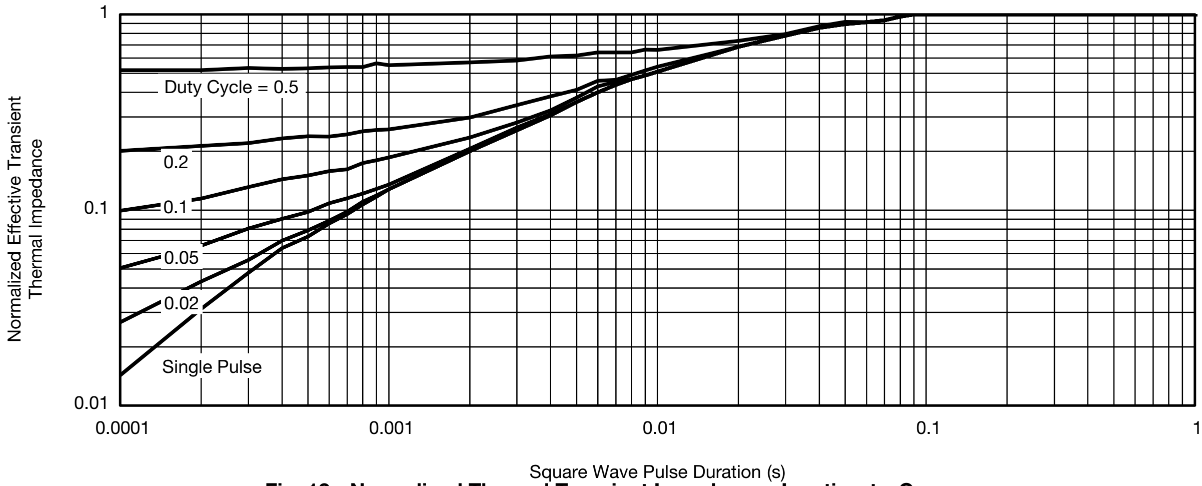


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

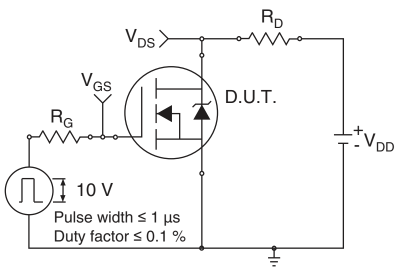


Fig. 13 - Switching Time Test Circuit

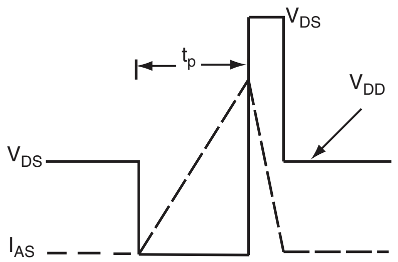


Fig. 16 - Unclamped Inductive Waveforms

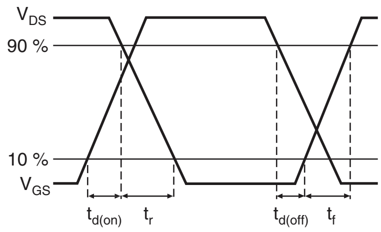


Fig. 14 - Switching Time Waveforms

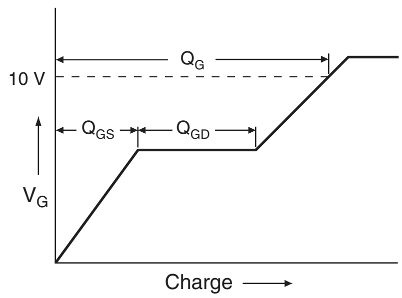


Fig. 17 - Basic Gate Charge Waveform

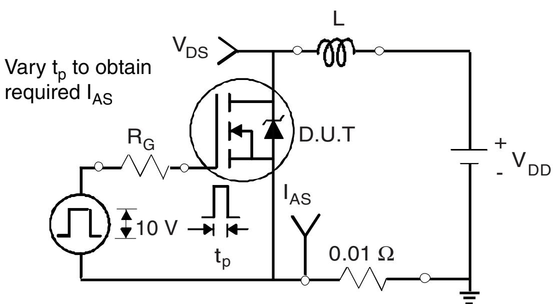


Fig. 15 - Unclamped Inductive Test Circuit

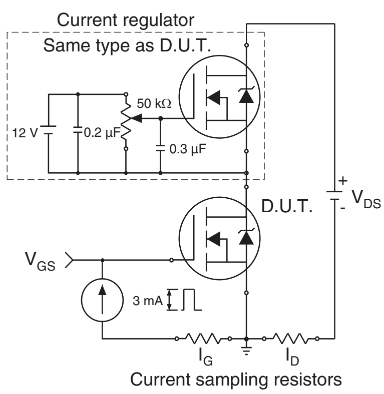
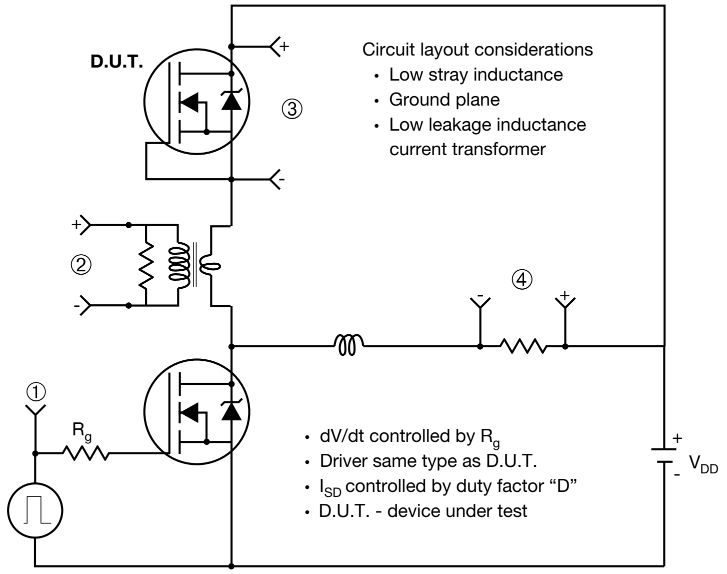
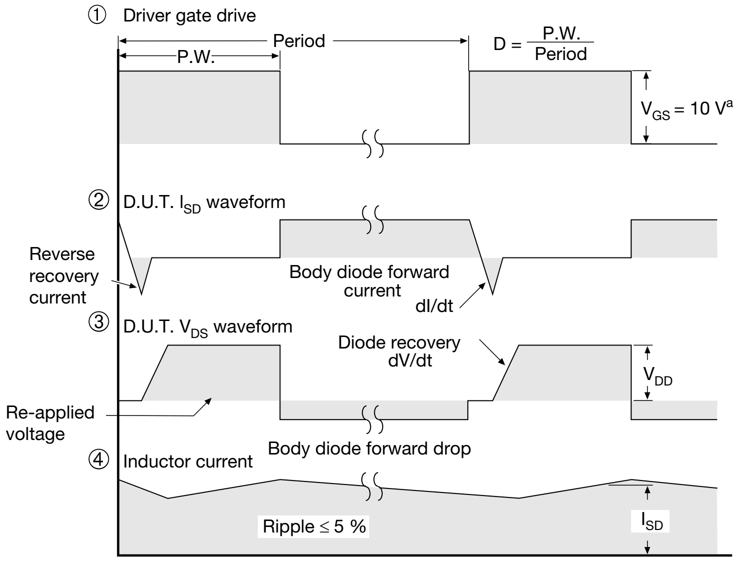


Fig. 18 - Gate Charge Test Circuit

Peak Diode Recovery dV/dt Test Circuit





Note

a. V_{GS} = 5 V for logic level devices

Fig. 19 - For N-Channel

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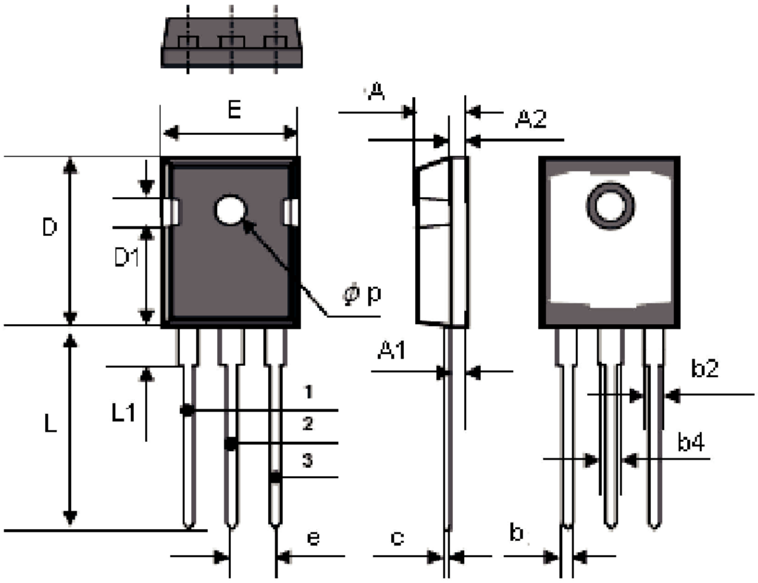
Package Information

Vishay Siliconix

TO-247AD (HIGH VOLTAGE)



DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.90	5.10	0.193	0.200
A1	2.30	2.40	0.090	0.094
A2	1.92	2.08	0.076	0.082
b	1.15	1.25	0.045	0.049
b2	1.95	2.05	0.077	0.081
b4	2.85	3.11	0.112	0.122
c	0.6 BSC		0.024 BSC	
D	20.80	21.46	0.819	0.845
D1	4.37	4.63	0.172	0.182
e	5.32	5.58	0.209	0.220
E	15.77	16.03	0.621	0.631
L	19.85	20.11	0.781	0.792
L1	4.07	4.33	0.160	0.170
Ø p	3.56	3.66	0.140	0.144

ECN: X12-0191-Rev. A, 22-Oct-12
DWG: 6010

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